

HEF4051B

8-channel analog multiplexer/demultiplexer

Rev. 14 — 25 July 2024

Product data sheet

1. General description

The HEF4051B is a single-pole octal-throw analog switch (SP8T) suitable for use in analog or digital 8:1 multiplexer/demultiplexer applications. The switch features three digital select inputs (S1, S2 and S3), eight independent inputs/outputs (Yn), a common input/output (Z) and a digital enable input (E). When E is HIGH, the switches are turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 3.0 V to 15.0 V
- CMOS low power dissipation
- High noise immunity
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Complies with JEDEC standard JESD 13-B
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Applications

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature Range	Name	Description	Version
HEF4051BT	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
HEF4051BTT	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

5. Functional diagram

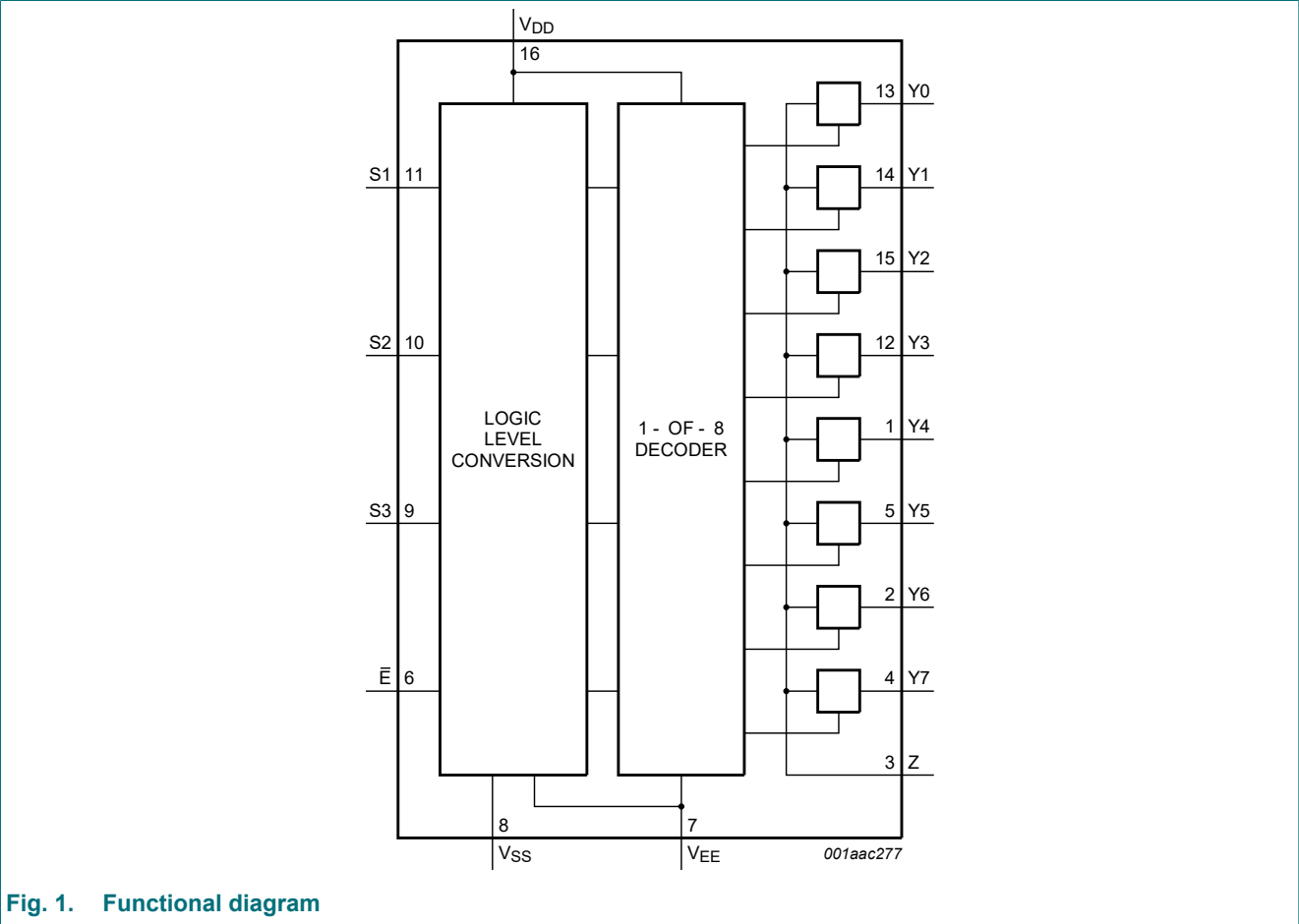


Fig. 1. Functional diagram

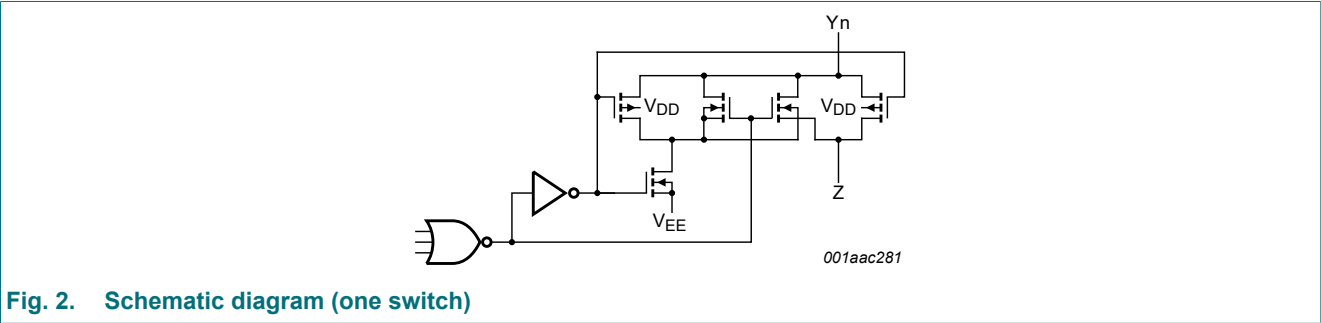


Fig. 2. Schematic diagram (one switch)

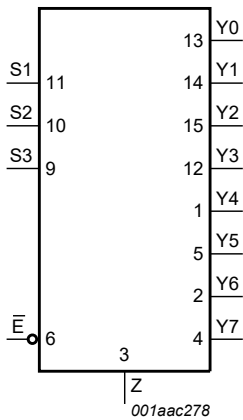


Fig. 3. Logic symbol

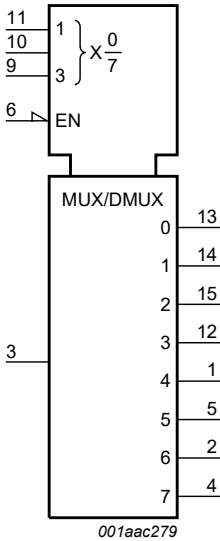


Fig. 4. IEC logic symbol

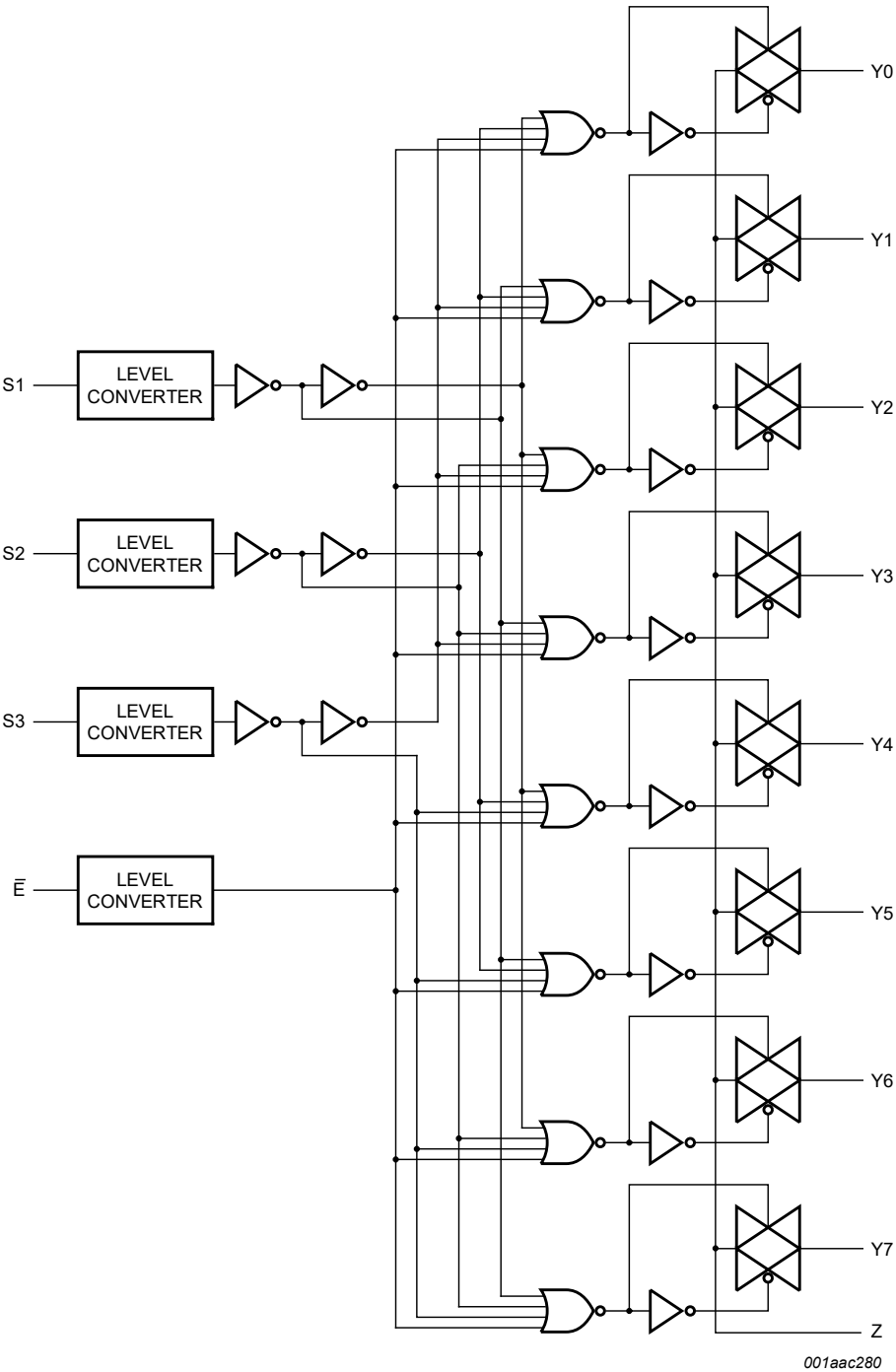
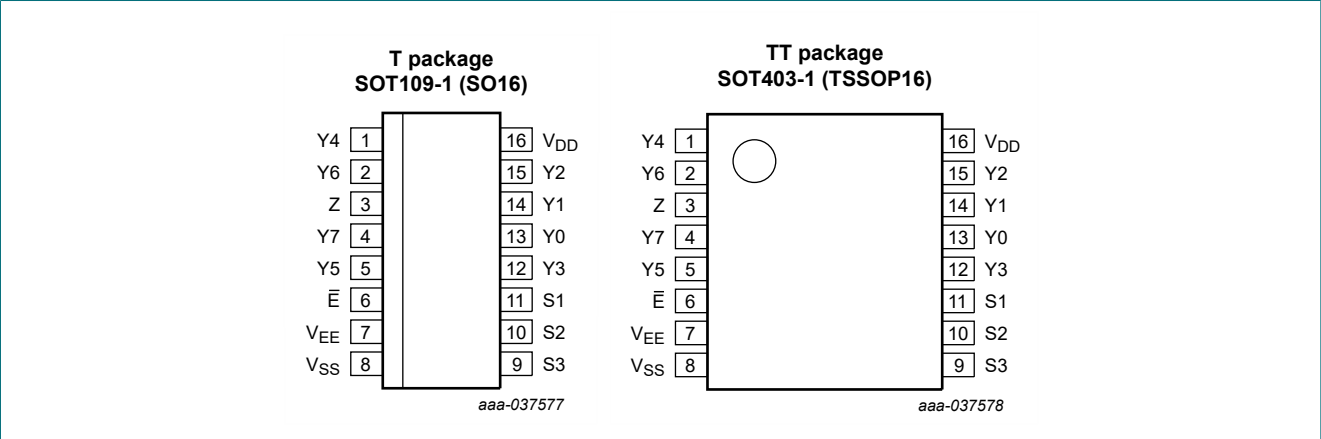


Fig. 5. Logic diagram

6. Pinning information

6.1. Pinning



8. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{SS} = 0\text{ V}$ (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+18	V
V_{EE}	supply voltage	referenced to V_{DD} [1]	-18	+0.5	V
I_{IK}	input clamping current	pins Sn and E; $V_I < -0.5\text{ V}$ or $V_I > V_{DD} + 0.5\text{ V}$	-	± 10	mA
V_I	input voltage		-0.5	$V_{DD} + 0.5$	V
$I_{I/O}$	input/output current		-	± 10	mA
I_{DD}	supply current		-	50	mA
T_{stg}	storage temperature		-65	+150	°C
T_{amb}	ambient temperature		-40	+125	°C
P_{tot}	total power dissipation	$T_{amb} = -40\text{ °C to }+125\text{ °C}$ [2]	-	500	mW
P	power dissipation	per output	-	100	mW

- [1] To avoid drawing V_{DD} current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{DD} current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V_{DD} or V_{EE} .
- [2] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.
For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DD}	supply voltage	see Fig. 6	3	-	15	V
V_I	input voltage		0	-	V_{DD}	V
T_{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD} = 5\text{ V}$	-	-	3.75	$\mu\text{s/V}$
		$V_{DD} = 10\text{ V}$	-	-	0.5	$\mu\text{s/V}$
		$V_{DD} = 15\text{ V}$	-	-	0.08	$\mu\text{s/V}$

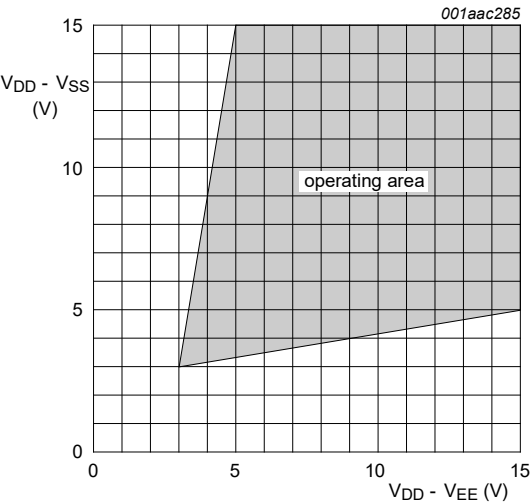


Fig. 6. Operating area as a function of the supply voltages

10. Static characteristics

Table 6. Static characteristics

$V_{SS} = V_{EE} = 0\text{ V}$; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} = -40 °C		T _{amb} = 25 °C		T _{amb} = 85 °C		T _{amb} = 125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level input voltage	I _O < 1 µA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V _{IL}	LOW-level input voltage	I _O < 1 µA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
I _I	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	µA
I _{S(OFF)}	OFF-state leakage current	Z port; all channels OFF; see Fig. 7	15 V	-	-	-	1000	-	-	-	-	nA
		Y port; per channel; see Fig. 8	15 V	-	-	-	200	-	-	-	-	nA
I _{DD}	supply current	I _O = 0 A	5 V	-	5	-	5	-	150	-	150	µA
			10 V	-	10	-	10	-	300	-	300	µA
			15 V	-	20	-	20	-	600	-	600	µA
C _I	input capacitance	Sn, E inputs	-	-	-	-	7.5	-	-	-	-	pF

10.1. Test circuits

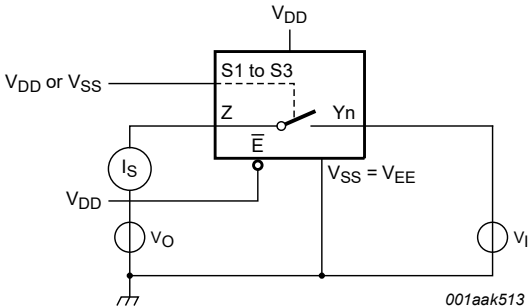


Fig. 7. Test circuit for measuring OFF-state leakage current Z port

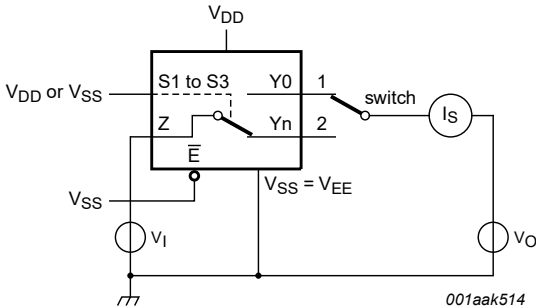


Fig. 8. Test circuit for measuring OFF-state leakage current Yn port

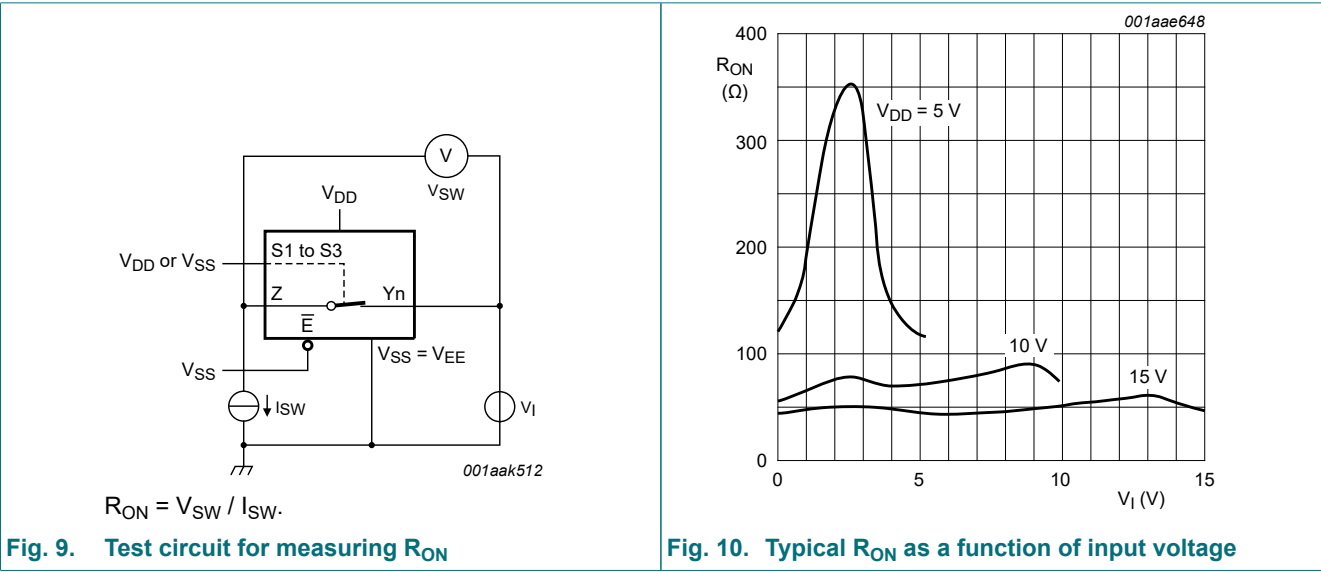
10.2. ON resistance

Table 7. ON resistance

$T_{amb} = 25\text{ }^{\circ}\text{C}$; $I_{SW} = 200\text{ }\mu\text{A}$; $V_{SS} = V_{EE} = 0\text{ V}$.

Symbol	Parameter	Conditions	$V_{DD} - V_{EE}$	Typ	Max	Unit
$R_{ON(peak)}$	ON resistance (peak)	$V_I = 0\text{ V to }V_{DD} - V_{EE}$; see Fig. 9 and Fig. 10	5 V	350	2500	Ω
			10 V	80	245	Ω
			15 V	60	175	Ω
$R_{ON(rail)}$	ON resistance (rail)	$V_I = 0\text{ V}$; see Fig. 9 and Fig. 10	5 V	115	340	Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
		$V_I = V_{DD} - V_{EE}$; see Fig. 9 and Fig. 10	5 V	120	365	Ω
			10 V	65	200	Ω
			15 V	50	155	Ω
ΔR_{ON}	ON resistance mismatch between channels	$V_I = 0\text{ V to }V_{DD} - V_{EE}$; see Fig. 9	5 V	25	-	Ω
			10 V	10	-	Ω
			15 V	5	-	Ω

10.2.1. ON resistance waveform and test circuit



11. Dynamic characteristics

Table 8. Dynamic characteristics
 $T_{amb} = 25\text{ }^{\circ}\text{C}$; $V_{SS} = V_{EE} = 0\text{ V}$; for test circuit see [Fig. 14](#).

Symbol	Parameter	Conditions	V _{DD}	Typ	Max	Unit
t _{PHL}	HIGH to LOW propagation delay	Y _n , Z to Z, Y _n ; see Fig. 11	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		S _n to Y _n , Z; see Fig. 12	5 V	150	300	ns
			10 V	60	120	ns
			15 V	45	90	ns
t _{PLH}	LOW to HIGH propagation delay	Y _n , Z to Z, Y _n ; see Fig. 11	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		S _n to Y _n , Z; see Fig. 12	5 V	150	300	ns
			10 V	65	130	ns
			15 V	45	90	ns
t _{PHZ}	HIGH to OFF-state propagation delay	\bar{E} to Y _n , Z; see Fig. 13	5 V	120	240	ns
			10 V	90	180	ns
			15 V	85	170	ns
t _{PZH}	OFF-state to HIGH propagation delay	\bar{E} to Y _n , Z; see Fig. 13	5 V	140	280	ns
			10 V	55	110	ns
			15 V	40	80	ns
t _{PLZ}	LOW to OFF-state propagation delay	\bar{E} to Y _n , Z; see Fig. 13	5 V	145	290	ns
			10 V	120	240	ns
			15 V	115	230	ns
t _{PZL}	OFF-state to LOW propagation delay	\bar{E} to Y _n , Z; see Fig. 13	5 V	140	280	ns
			10 V	55	110	ns
			15 V	40	80	ns

11.1. Waveforms and test circuit

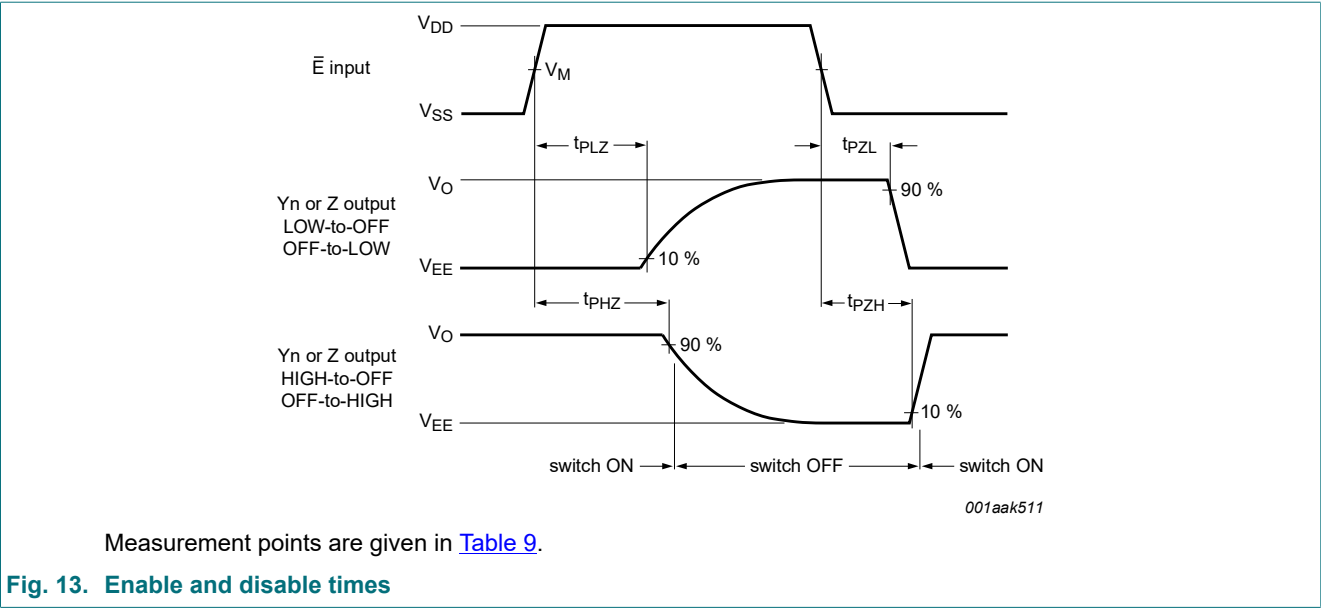
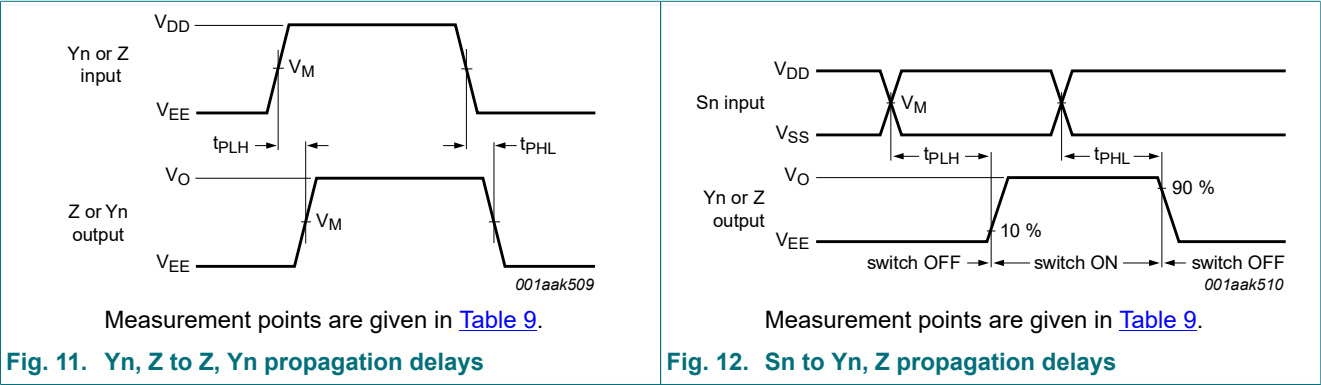
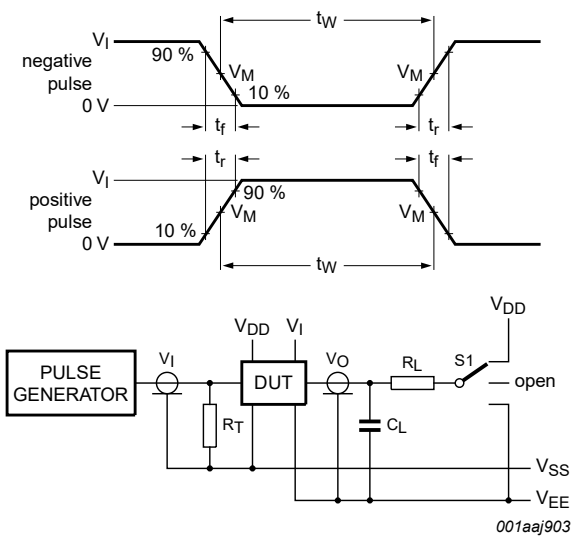


Table 9. Measurement points

Supply voltage	Input	Output
V_{DD}	V_M	V_M
5 V to 15 V	$0.5V_{DD}$	$0.5V_{DD}$



Test data is given in [Table 10](#).
Definitions test circuit:
 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;
 C_L = Load capacitance including test jig and probe;
 R_L = Load resistance.

Fig. 14. Test circuit for measuring switching times

Table 10. Test data

Input				Load		S1 position				
Yn, Z	Sn and \bar{E}	t_r, t_f	V_M	C_L	R_L	t_{PHL} [1]	t_{PLH}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}	other
V_{DD} or V_{EE}	V_{DD} or V_{SS}	≤ 20 ns	$0.5V_{DD}$	50 pF	10 k Ω	V_{DD} or V_{EE}	V_{EE}	V_{EE}	V_{DD}	V_{EE}

[1] For Yn to Z or Z to Yn propagation delays use V_{EE} . For Sn to Yn or Z propagation delays use V_{DD} .

11.2. Additional dynamic parameters

Table 11. Additional dynamic characteristics

$V_{SS} = V_{EE} = 0$ V; $T_{amb} = 25$ °C.

Symbol	Parameter	Conditions	V_{DD}	Typ	Max	Unit
THD	total harmonic distortion	see Fig. 15 ; $R_L = 10$ k Ω ; $C_L = 15$ pF; channel ON; $V_I = 0.5V_{DD}$ (p-p); $f_i = 1$ kHz	5 V	[1] 0.25	-	%
			10 V	[1] 0.04	-	%
			15 V	[1] 0.04	-	%
$f_{(-3dB)}$	-3 dB frequency response	see Fig. 16 ; $R_L = 1$ k Ω ; $C_L = 5$ pF; channel ON; $V_I = 0.5V_{DD}$ (p-p)	5 V	[1] 13	-	MHz
			10 V	[1] 40	-	MHz
			15 V	[1] 70	-	MHz
α_{iso}	isolation (OFF-state)	see Fig. 17 ; $f_i = 1$ MHz; $R_L = 1$ k Ω ; $C_L = 5$ pF; channel OFF; $V_I = 0.5V_{DD}$ (p-p)	10 V	[1] -50	-	dB
V_{ct}	crosstalk voltage	digital inputs to switch; see Fig. 18 ; $R_L = 10$ k Ω ; $C_L = 15$ pF; \bar{E} or Sn = V_{DD} (square-wave)	10 V	50	-	mV
Xtalk	crosstalk	between switches; see Fig. 19 ; $f_i = 1$ MHz; $R_L = 1$ k Ω ; $V_I = 0.5V_{DD}$ (p-p)	10 V	[1] -50	-	dB

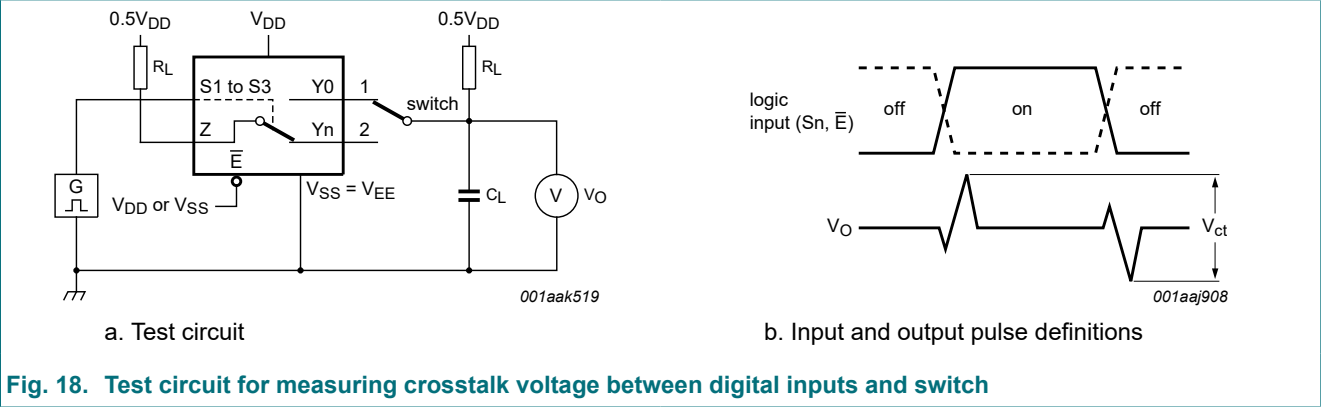
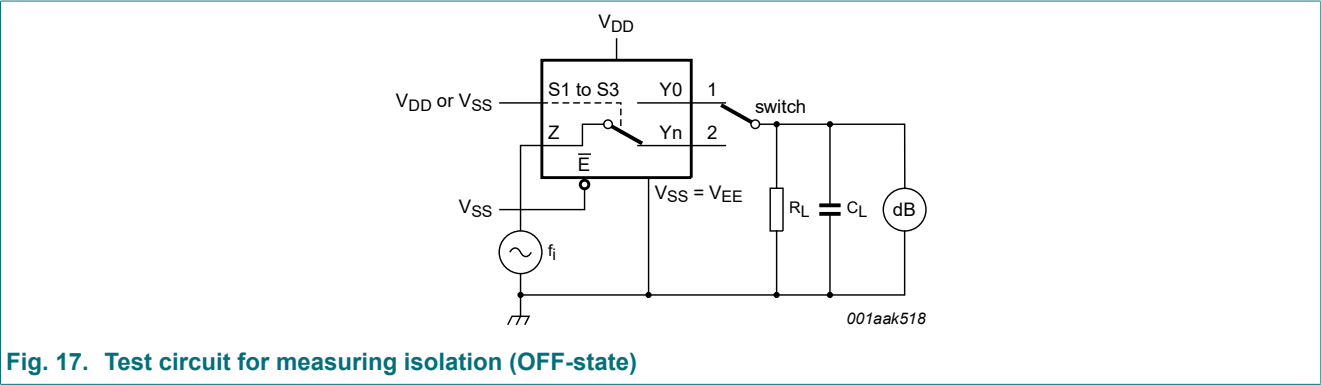
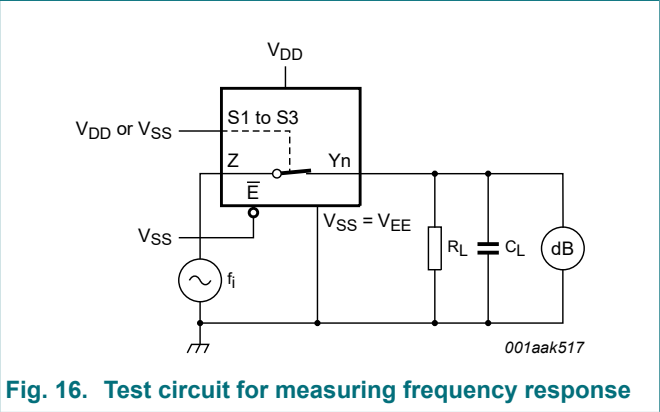
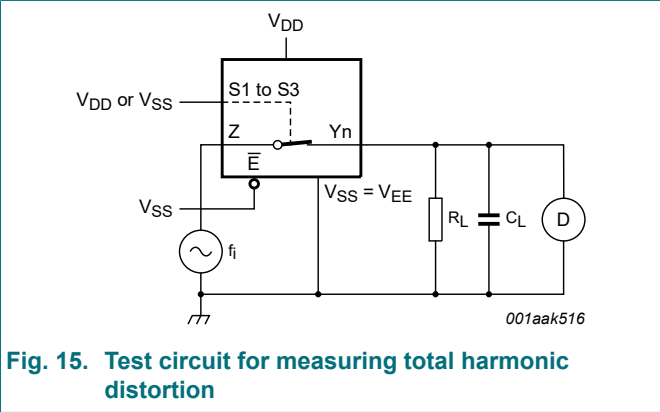
[1] f_i is biased at $0.5 V_{DD}$; $V_I = 0.5V_{DD}$ (p-p).

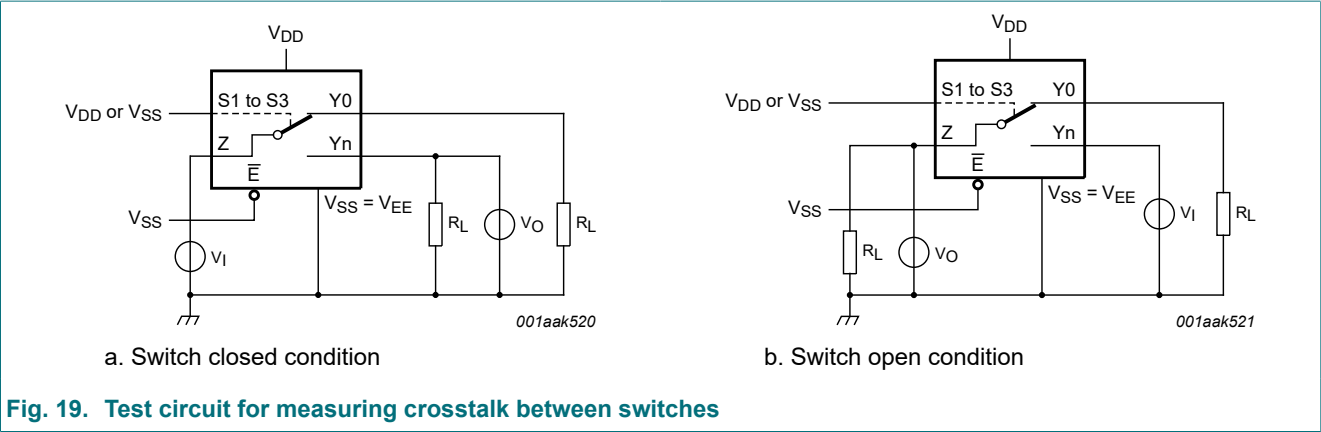
Table 12. Dynamic power dissipation P_D

P_D can be calculated from the formulas shown; $V_{EE} = V_{SS} = 0\text{ V}$; $t_r = t_f \leq 20\text{ ns}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$.

Symbol	Parameter	V_{DD}	Typical formula for P_D (μW)	where:
P_D	dynamic power dissipation	5 V	$P_D = 1000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF; V_{DD} = supply voltage in V; $\Sigma(C_L \times f_o)$ = sum of the outputs.
		10 V	$P_D = 5500 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	
		15 V	$P_D = 15000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	

11.2.1. Test circuits





12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

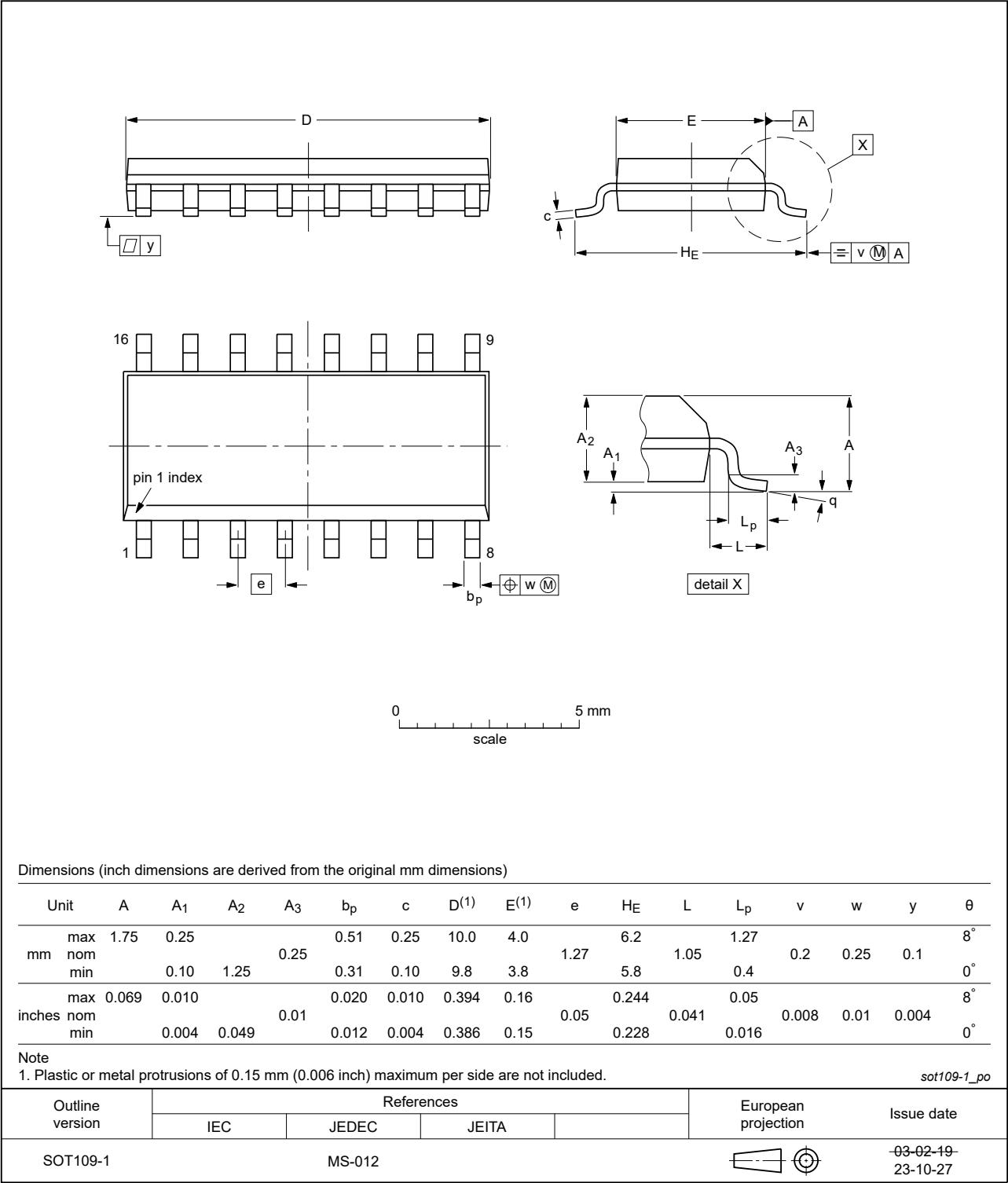


Fig. 20. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

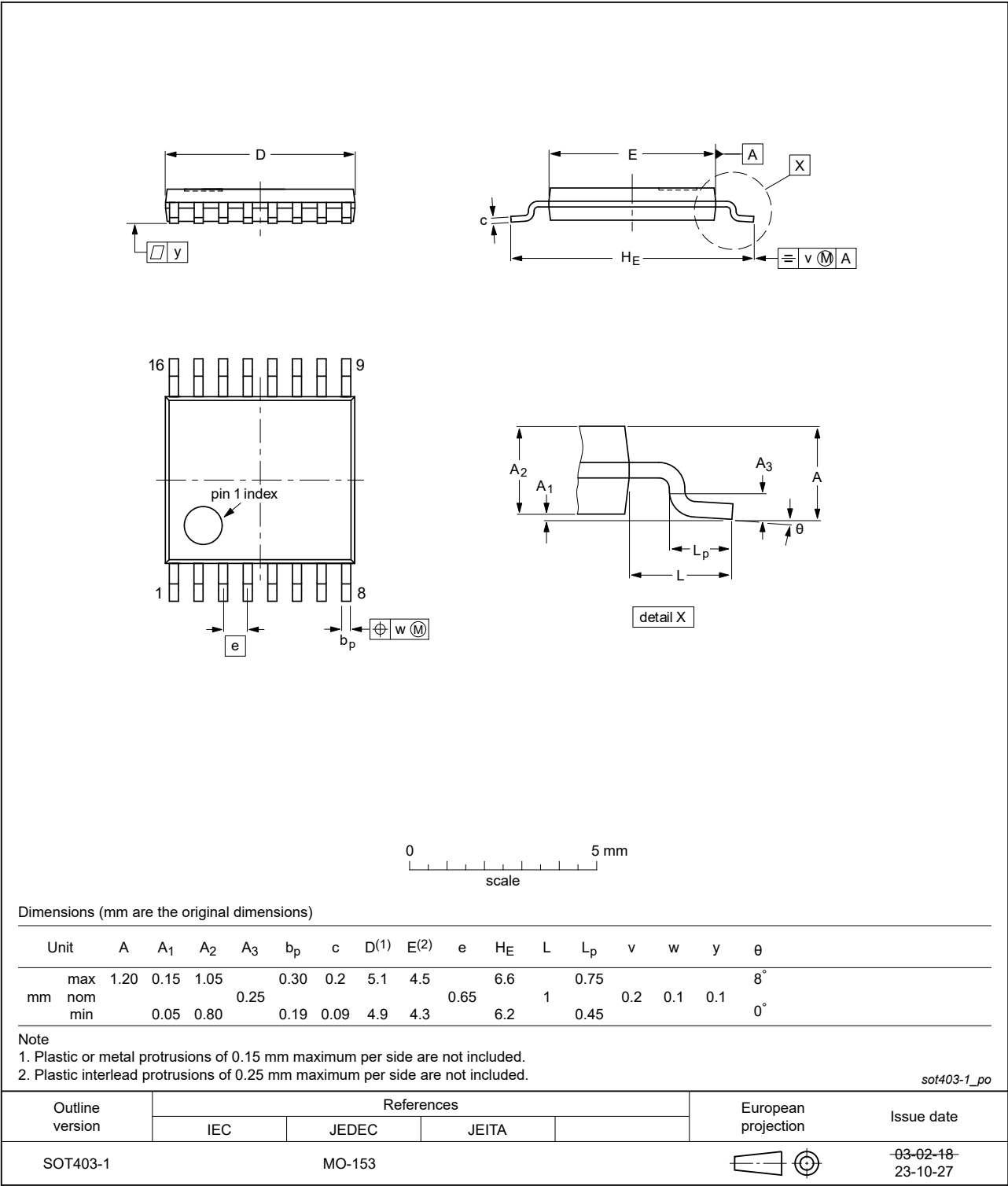


Fig. 21. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 13. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
HBM	Human Body Model
JEDEC	Joint Electron Device Engineering Council

14. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4051B v.14	20240725	Product data sheet	-	HEF4051B v.13
Modifications:	<ul style="list-style-type: none">Section 2: ESD specification updated according to the latest JEDEC standard.Fig. 20, Fig. 21: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153			
HEF4051B v.13	20210729	Product data sheet	-	HEF4051B v.12
Modifications:	<ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.Legal texts have been adapted to the new company name where appropriate.Type number HEF4051BTS (SOT338-1/SSOP16) removed.Section 1 and Section 2 updated.Section 8: Derating values for P_{tot} total power dissipation updated.			
HEF4051B v.12	20160325	Product data sheet	-	HEF4051B v.11
Modifications:	<ul style="list-style-type: none">Type number HEF4051BP (SOT38-4) removed.			
HEF4051B v.11	20140911	Product data sheet	-	HEF4051B v.10
Modifications:	<ul style="list-style-type: none">Fig. 18: Test circuit modified			
HEF4051B v.10	20111117	Product data sheet	-	HEF4051B v.9
Modifications:	<ul style="list-style-type: none">Legal pages updated.Changes in "General description", "Features and benefits" and "Applications".			
HEF4051B v.9	20100325	Product data sheet	-	HEF4051B v.8
HEF4051B v.8	20100301	Product data sheet	-	HEF4051B v.7
HEF4051B v.7	20091127	Product data sheet	-	HEF4051B v.6
HEF4051B v.6	20090924	Product data sheet	-	HEF4051B v.5
HEF4051B v.5	20090826	Product data sheet	-	HEF4051B v.4
HEF4051B v.4	20050112	Product data sheet	-	HEF4051B_CNV v.3
HEF4051B_CNV v.3	19950101	Product specification	-	HEF4051B_CNV v.2
HEF4051B_CNV v.2	19950101	Product specification	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal

injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nexperia.com/profile/terms>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Contents

1. General description..... 1

2. Features and benefits..... 1

3. Applications..... 1

4. Ordering information..... 1

5. Functional diagram.....2

6. Pinning information.....5

6.1. Pinning.....5

6.2. Pin description..... 5

7. Functional description..... 5

8. Limiting values..... 6

9. Recommended operating conditions.....6

10. Static characteristics.....7

10.1. Test circuits..... 7

10.2. ON resistance..... 8

10.2.1. ON resistance waveform and test circuit..... 8

11. Dynamic characteristics.....9

11.1. Waveforms and test circuit.....10

11.2. Additional dynamic parameters..... 11

11.2.1. Test circuits..... 12

12. Package outline..... 14

13. Abbreviations..... 16

14. Revision history.....16

15. Legal information.....17

© Nexperia B.V. 2024. All rights reserved

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: salesaddresses@nexperia.com

Date of release: 25 July 2024